



# 70N06

**Power MOSFET**

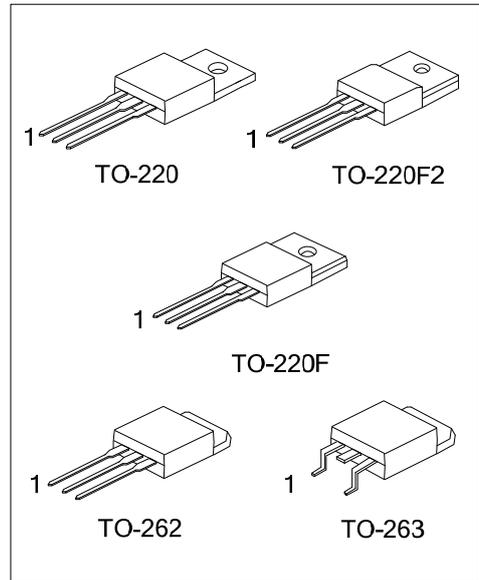
## 70A, 60V N-CHANNEL POWER MOSFET

■ DESCRIPTION

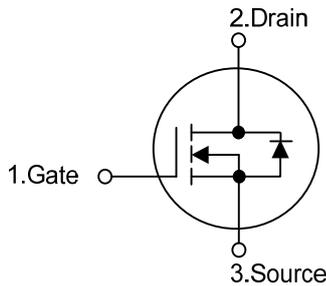
The UTC **70N06** is n-channel enhancement mode power field effect transistors with stable off-state characteristics, fast switching speed, low thermal resistance, usually used at telecom and computer application.

■ FEATURES

- \*  $R_{DS(ON)} < 15\text{ m}\Omega$  @  $V_{GS}=10\text{V}$ ,  $I_D=35\text{A}$
- \* Fast switching capability
- \* Avalanche energy specified
- \* Improved dv/dt capability



■ SYMBOL



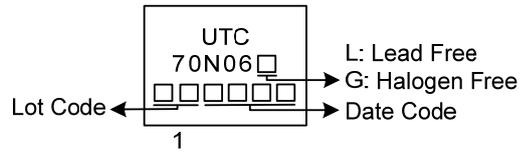
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
70N06L-TA3-T	70N06G-TA3-T	TO-220	G	D	S	Tube
70N06L-TF3-T	70N06G-TF3-T	TO-220F	G	D	S	Tube
70N06L-TF2-T	70N06G-TF2-T	TO-220F2	G	D	S	Tube
70N06L-T2Q-T	70N06G-T2Q-T	TO-262	G	D	S	Tube
70N06L-TQ2-T	70N06G-TQ2-T	TO-263	G	D	S	Tube
70N06L-TQ2-R	70N06G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>70N06G-TA3-T</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) R: Tape Reel, T: Tube (2) TA3: TO-220, TF3: TO-220F, TF2: TO-220F2 T2Q: TO-262, TQ2: TO-263 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
--	--

■ MARKING



### ■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	60	V
Gate-Source Voltage		$V_{GSS}$	±20	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	$I_D$	70	A
	$T_C = 100^\circ\text{C}$		42	A
Drain Current Pulsed (Note 2)		$I_{DM}$	140	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	600	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	10	V/ns
Power Dissipation	TO-220/TO-262/TO-263	$P_D$	125	W
	TO-220F		36	W
	TO-220F2		38	W
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repeativity rating: pulse width limited by junction temperature

3.  $L=0.24\text{mH}$ ,  $I_{AS}=70\text{A}$ ,  $V_{DD}=25\text{V}$ ,  $R_G=20\Omega$ , Starting  $T_J=25^\circ\text{C}$

4.  $I_{SD}\leq 48\text{A}$ ,  $di/dt\leq 300\text{A}/\mu\text{s}$ ,  $V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$

### ■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		$\theta_{JA}$	62	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220/TO-262/TO-263	$\theta_{JC}$	1	$^\circ\text{C}/\text{W}$
	TO-220F		3.47	$^\circ\text{C}/\text{W}$
	TO-220F2		3.28	$^\circ\text{C}/\text{W}$

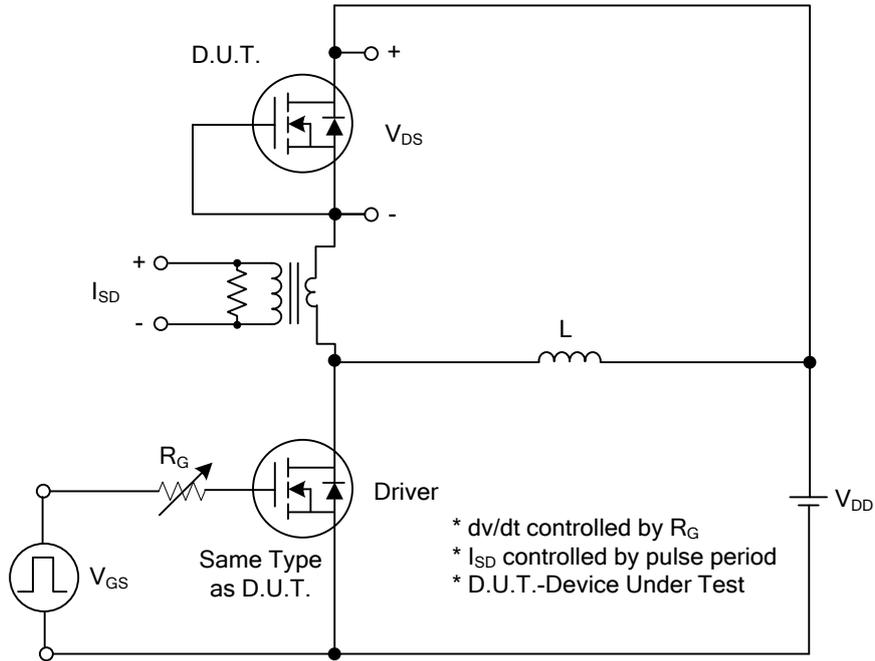
■ ELECTRICAL CHARACTERISTICS (T<sub>c</sub> = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μA
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>			100	nA
	Reverse					
		V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0		4.0	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =35A			15	mΩ
<b>DYNAMIC CHARACTERISTICS</b>						
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, f=1MHz		1800	2000	pF
Output Capacitance	C <sub>OSS</sub>			800	900	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			130	150	pF
<b>SWITCHING CHARACTERISTICS</b>						
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> =48V, V <sub>GS</sub> =10V, I <sub>D</sub> =70A, I <sub>G</sub> =1mA (Note1, 2)		60		nC
Gate-Source Charge	Q <sub>GS</sub>			12		nC
Gate-Drain Charge (Miller Charge)	Q <sub>GD</sub>			27		nC
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =70A (Note1,2)		22		ns
Turn-On Rise Time	t <sub>R</sub>			55		ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			125		ns
Turn-Off Fall Time	t <sub>F</sub>			56		ns
<b>DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS</b>						
Maximum Continuous Drain-Source Diode Forward Current	I <sub>S</sub>				70	A
Maximum Pulsed Drain-Source Diode Forward Current	I <sub>SM</sub>				140	
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =70A			1.4	V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =30A dI <sub>F</sub> /dt=100A/μs		95		ns
Reverse Recovery Charge	Q <sub>RR</sub>			250		nC

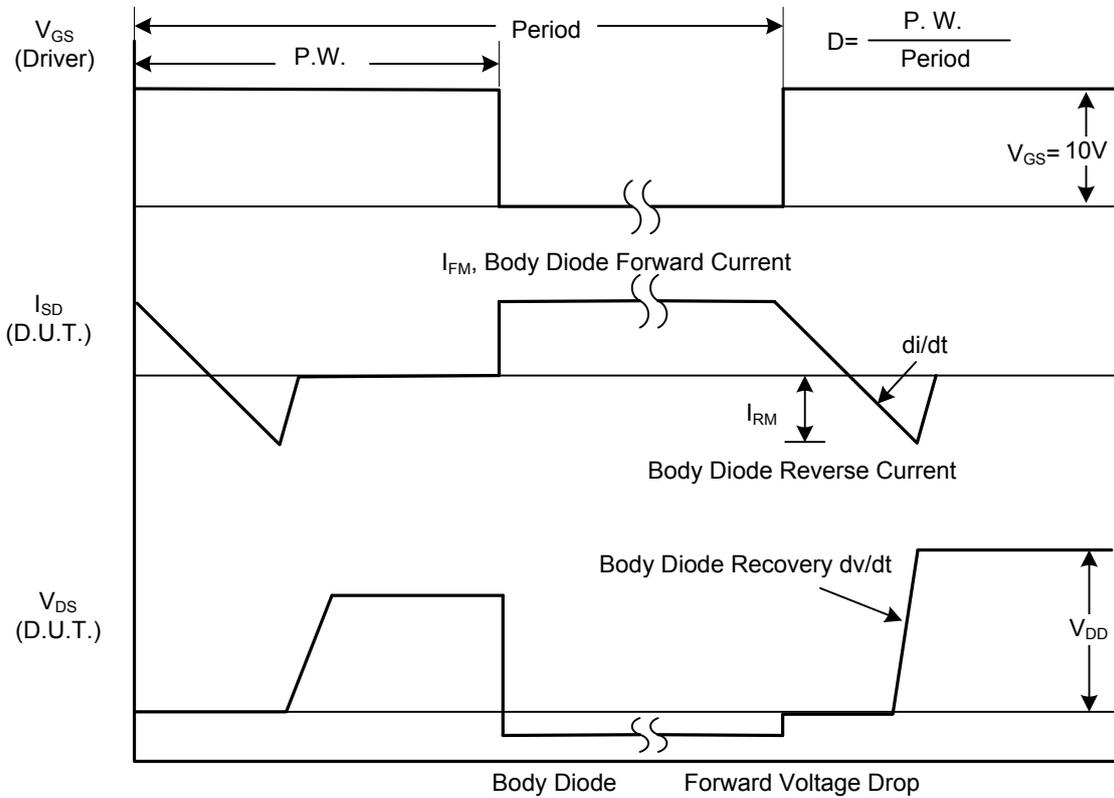
Notes: 1. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS



1A Peak Diode Recovery dv/dt Test Circuit



1B Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS

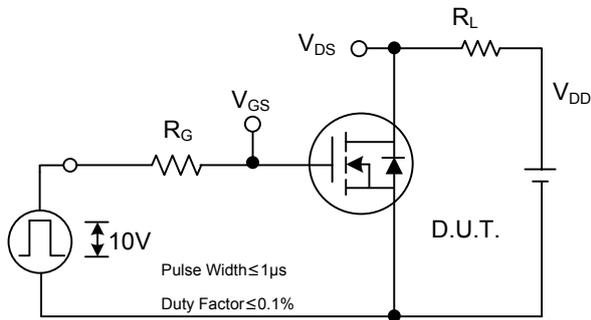


Fig. 2A Switching Test Circuit

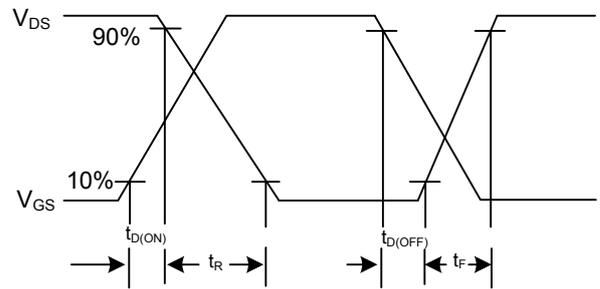


Fig. 2B Switching Waveforms

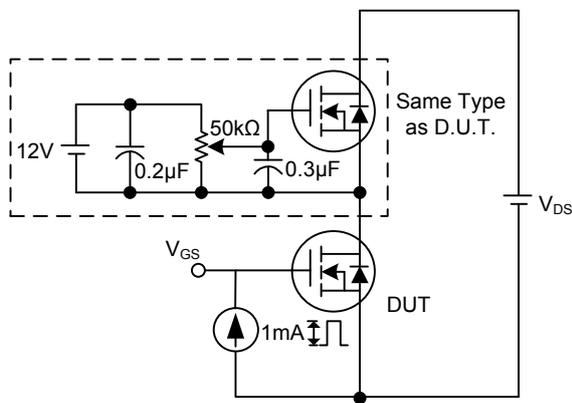


Fig. 3A Gate Charge Test Circuit

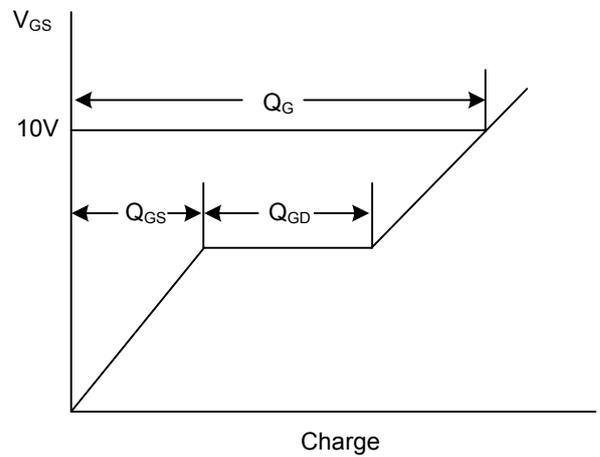


Fig. 3B Gate Charge Waveform

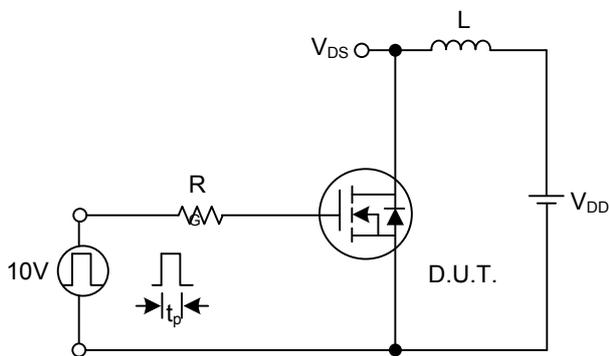


Fig. 4A Unclamped Inductive Switching Test Circuit

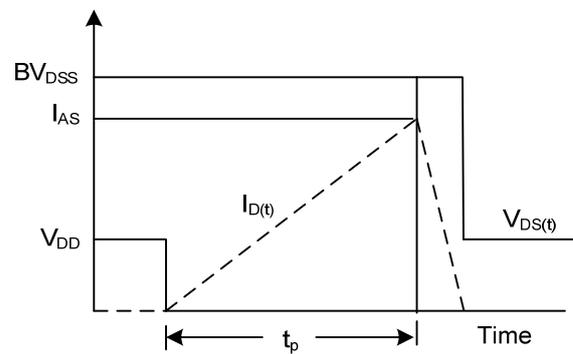
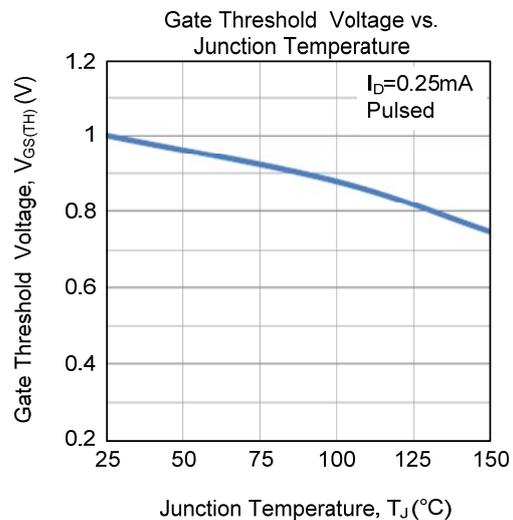
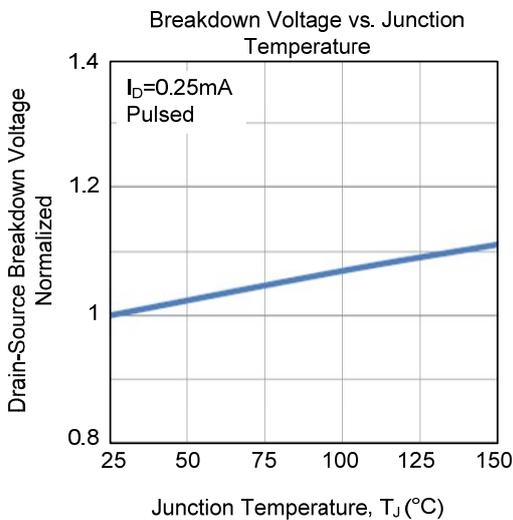
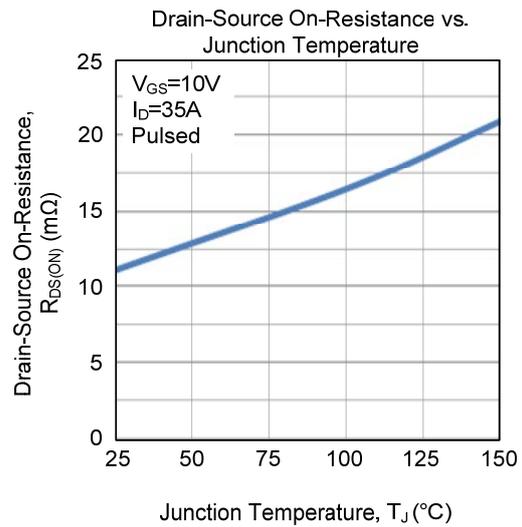
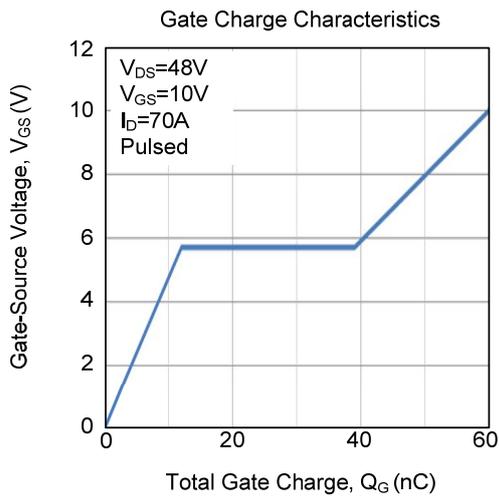
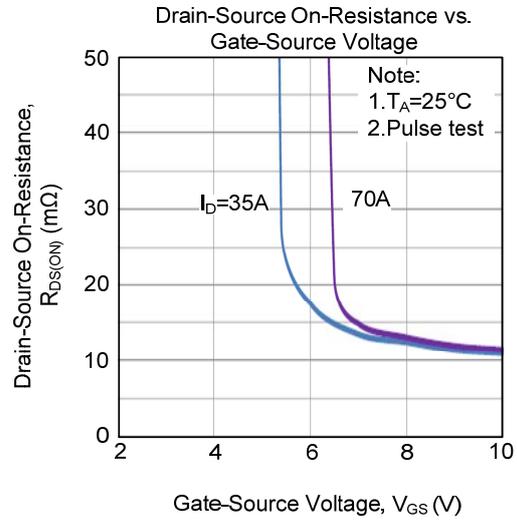
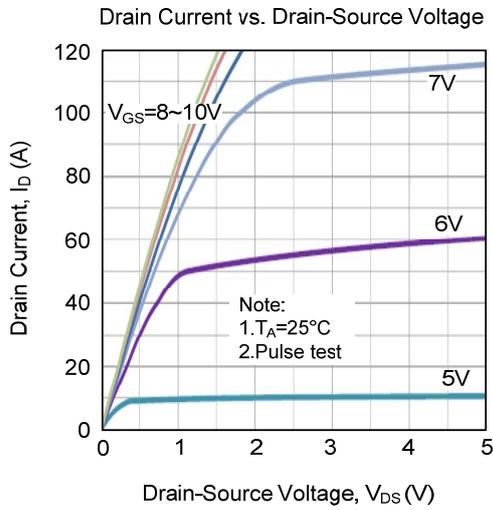
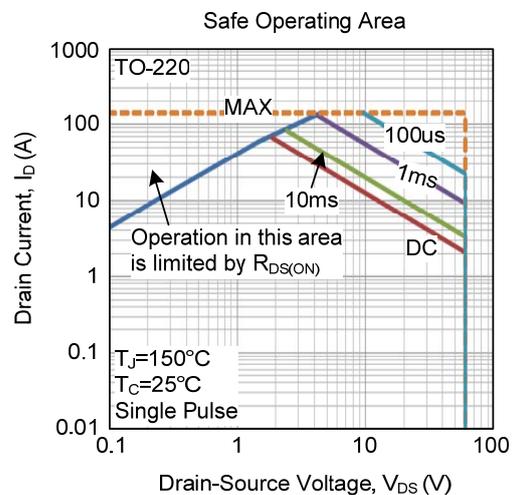
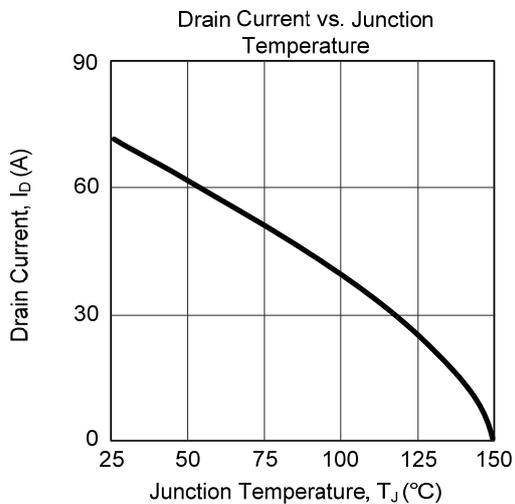
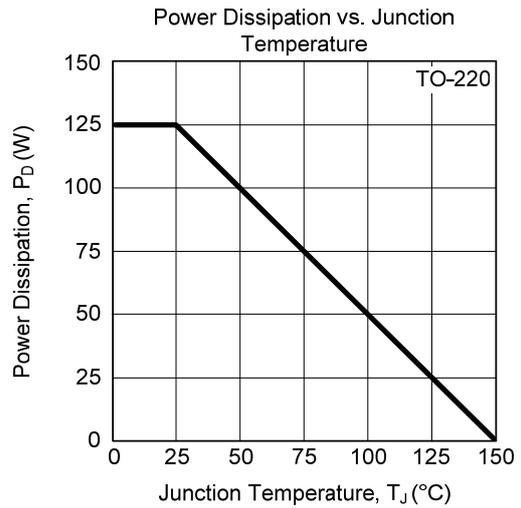
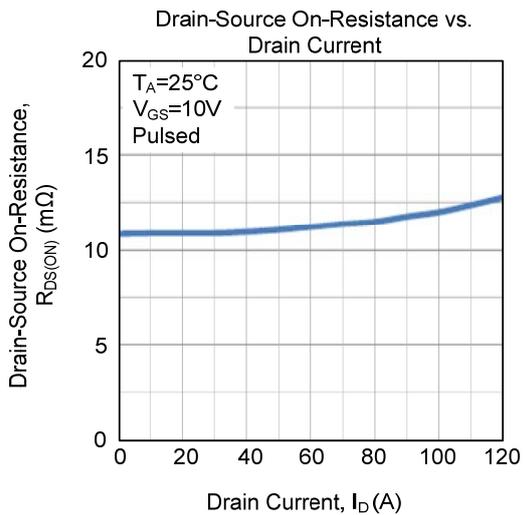
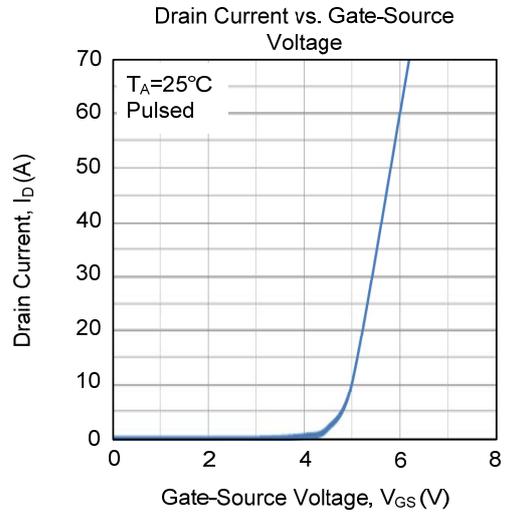
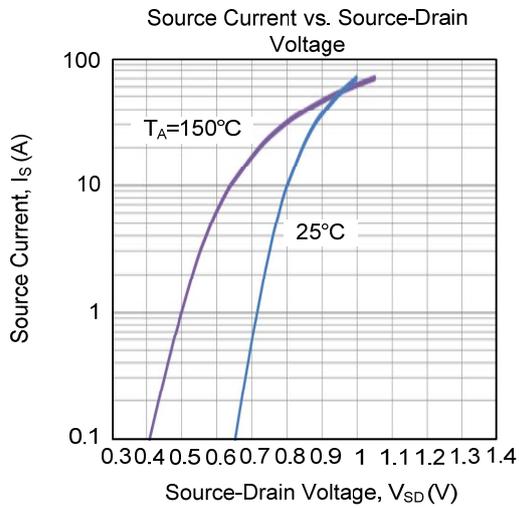


Fig. 4B Unclamped Inductive Switching Waveforms

## TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.